### **Notice for TAIYO YUDEN Products**

[ For High Quality and/or Reliability Equipment (Automotive Electronic Equipment / Industrial Equipment)]

Please read this notice before using the TAIYO YUDEN products.

#### !\ REMINDERS

Product information in this catalog is as of October 2018. All of the contents specified herein are subject to change without notice due to technical improvements, etc. Therefore, please check for the latest information carefully before practical application or use of our products.

Please note that TAIYO YUDEN shall not be in any way responsible for any damages and defects in products or equipment incorporating our products, which are caused under the conditions other than those specified in this catalog or individual product specification sheets.

- Please contact TAIYO YUDEN for further details of product specifications as the individual product specification sheets are available.
- Please conduct validation and verification of our products in actual condition of mounting and operating environment before using our products.
- The products listed in this catalog are intended for use in general electronic equipment (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment), medical equipment classified as Class I or II by IMDRF, industrial equipment, and automotive interior applications, etc. Please be sure to contact TAIYO YUDEN for further information before using the products for any equipment which may directly cause loss of human life or bodily injury (e.g., transportation equipment including, without limitation, automotive powertrain control system, train control system, and ship control system, traffic signal equipment, medical equipment classified as Class III by IMDRF).

Please do not incorporate our products into any equipment requiring high levels of safety and/or reliability (e.g., aerospace equipment, aviation equipment\*, medical equipment classified as Class IV by IMDRF, nuclear control equipment, undersea equipment, military equipment).

\*Note: There is a possibility that our products can be used only for aviation equipment that does not directly affect the safe operation of aircraft (e.g., in-flight entertainment, cabin light, electric seat, cooking equipment) if such use meets requirements specified separately by TAIYO YUDEN. Please be sure to contact TAIYO YUDEN for further information before using our products for such aviation equipment.

When our products are used even for high safety and/or reliability-required devices or circuits of general electronic equipment, it is strongly recommended to perform a thorough safety evaluation prior to use of our products and to install a protection circuit as necessary.

Please note that unless you obtain prior written consent of TAIYO YUDEN, TAIYO YUDEN shall not be in any way responsible for any damages incurred by you or third parties arising from use of the products listed in this catalog for any equipment requiring inquiry to TAIYO YUDEN or prohibited for use by TAIYO YUDEN as described above.

- Information contained in this catalog is intended to convey examples of typical performances and/or applications of our products and is not intended to make any warranty with respect to the intellectual property rights or any other related rights of TAIYO YUDEN or any third parties nor grant any license under such rights.
- Please note that the scope of warranty for our products is limited to the delivered our products themselves and TAIYO YUDEN shall not be in any way responsible for any damages resulting from a fault or defect in our products. Notwithstanding the foregoing, if there is a written agreement (e.g., supply and purchase agreement, quality assurance agreement) signed by TAIYO YUDEN and your company, TAIYO YUDEN will warrant our products in accordance with such agreement.
- The contents of this catalog are applicable to our products which are purchased from our sales offices or authorized distributors (hereinafter "TAIYO YUDEN's official sales channel"). Please note that the contents of this catalog are not applicable to our products purchased from any seller other than TAIYO YUDEN's official sales channel.
- Caution for Export
  Some of our products listed in this catalog may require specific procedures for export according to "U.S. Export Administration Regulations", "Foreign Exchange and Foreign Trade Control Law" of Japan, and other applicable regulations. Should you have any questions on this matter, please contact our sales staff.

## **Automotive Application Guide**

We classify automotive electronic equipment into the following four application categories and set usable application categories for each of our products. When using our products for automotive electronic equipment, please be sure to check such application categories and use our products accordingly. Should you have any questions on this matter, please contact us.

Category	Automotive Electronic Equipment (Typical Example)
	Engine ECU (Electronically Controlled Fuel Injector)
	Cruise Control Unit
	• 4WS (4 Wheel Steering)
POWERTRAIN	Automatic Transmission
	Power Steering
	HEV/PHV/EV Core Control (Battery, Inverter, DC-DC)
	Automotive Locator (Car location information providing device), etc.
	ABS (Anti-Lock Brake System)
SAFETY	• ESC (Electronic Stability Control)
SALLII	• Airbag
	ADAS (Equipment that directly controls running, turning and stopping), etc.
	• Wiper
	Automatic Door
	• Power Window
	Keyless Entry System
BODY & CHASSIS	• Electric Door Mirror
	• Interior Lighting
	• LED Headlight
	• TPMS (Tire Pressure Monitoring System)
	Anti-Theft Device (Immobilizer), etc.
	Car Infotainment System
INFOTAINMENT	• ITS/Telematics System
	• Instrument Cluster
	• ADAS (Sensor, Equipment that is not interlocked with safety equipment or powertrain), etc.

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# INDUCTORS \ POWER INDUCTORS

## WIRE-WOUND CHIP POWER INDUCTORS(CB SERIES)



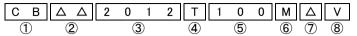


REFLOW

#### ■PART NUMBER

\*Operating Temp. : -40~105°C (Including self-generated heat)

△=Blank space



#### ①Series name

0 1		
	Code	Series name
	CB	Wound chip power inductor

#### ②Characteristics

Code	Characteristics
ΔΔ	Standard
ΔC	High current

#### ③Dimensions (L × W)

Code	Type (inch)	Dimensions (L×W) [mm]
2012	2012 (0805)	2.0 × 1.25
2016	2016 (0806)	2.0 × 1.6
2518	2518(1007)	2.5 × 1.8
3225	3225(1210)	3.2 × 2.5

#### 4 Packaging

Code	Packaging
Т	Taping

#### **⑤**Nominal inductance

Code (example)	Nominal inductance[ μH]
1R0	1.0
100	10
101	100

#### 6 Inductance tolerance

Code	Inductance tolerance			
K	±10%			
М	±20%			

#### 7 Special code

Code	Special code		
Δ	Standard		
R	Low Rdc type		

#### 8 Internal code

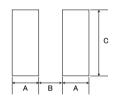
Code	Internal code			
٧	Inductor for Industrial and Automotive			

#### ■STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY



Surface Mounting

- •Mounting and soldering conditions should be checked beforehand.
- \*Applicable soldering process to these products is reflow soldering only.



Туре	Α	В	С
2012	0.60	1.0	1.45
2016	0.60	1.0	1.8
2518	0.60	1.5	2.0
3225	0.85	1.7	2.7
			Unit:mm

Туре		W	т		Standard quantity [pcs]	
Туре			_	е	Paper tape	Embossed tape
CB 2012 CB C2012	2.0±0.2 (0.079±0.008)	1.25±0.2 (0.049±0.008)	1.25±0.2 (0.049±0.008)			3000
CB 2016 CB C2016	2.0±0.2 (0.079±0.008)	1.6±0.2 (0.063±0.008)	1.6±0.2 (0.063±0.008)	0.5±0.2 (0.020±0.008)	_	2000
CB 2518 CB C2518	2.5±0.2 (0.098±0.008)	1.8±0.2 (0.071±0.008)	1.8±0.2 (0.071±0.008)	0.5±0.2 (0.020±0.008)	-	2000
CB C3225	3.2±0.2 (0.126±0.008)	2.5±0.2 (0.098±0.008)	2.5±0.2 (0.098±0.008)	0.6±0.3 (0.024±0.012)	_	1000

Unit:mm(inch)

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• All the Wire-wound Chip Power Inductors of the catalog lineup are RoHS compliant.

- The exchange of individual specifications is necessary depending on the application and circuit condition. Please contact Taiyo Yuden sales channels.
- \*2: Industrial products and Medical products

Please consult with TAIYO YUDEN's official sales channel for the details of the product specification, etc.,

and please review and approve TAIYO YUDEN's product specification before ordering.

Please be sure to contact us for further information before using the products for automotive electronic equipment.

#### **2012** (0805) type

	N		Self-resonant frequency [MHz] (min.)	DC Resistance	Rated curren	t ※)[mA]	Measuring frequency[MHz]	Note
Part number	Nominal inductance [ μ H]			$[\Omega](\pm 30\%)$	Saturation current Idc1	Temperature rise current Idc2		
CB 2012T1R0M V	1.0	±20%	100	0.15	500	700	7.96	*2
CB 2012T2R2M V	2.2	±20%	80	0.23	410	620	7.96	*2
CB 2012T3R3M V	3.3	±20%	55	0.30	330	550	7.96	*2
CB 2012T4R7M V	4.7	±20%	45	0.40	300	430	7.96	*2
CB 2012T6R8M V	6.8	±20%	38	0.47	250	350	7.96	*2
CB 2012T100[] V	10	±10%, ±20%	32	0.70	190	300	2.52	*2
CB 2012T100□RV	10	±10%, ±20%	32	0.50	200	300	2.52	*2
CB 2012T150[] V	15	±10%, ±20%	28	1.3	170	240	2.52	*2
CB 2012T220 V	22	±10%, ±20%	16	1.7	135	220	2.52	*2
CB 2012T470 V	47	±10%, ±20%	11	3.7	90	140	2.52	*2
CB 2012T680 U	68	±10%, ±20%	10	6.0	70	100	2.52	*2
CB 2012T101 V	100	±10%, ±20%	8	7.0	60	100	0.796	*2

	Nominal inductance		Self-resonant	DC Resistance	Rated curren	t ※)[mA]	Measuring	
Part number	[ $\mu$ H]	Inductance tolerance	frequency [MHz] (min.)	[Ω](±30%)	Saturation current Idc1	Temperature rise current Idc2	frequency[MHz]	Note
CB C2012T1R0M V	1.0	±20%	100	0.19	700	640	7.96	*2
CB C2012T2R2M V	2.2	±20%	70	0.33	530	485	7.96	*2
CB C2012T4R7M V	4.7	±20%	45	0.50	360	395	7.96	*2
CB C2012T100[] V	10	±10%, ±20%	40	1.2	240	255	2.52	*2
CB C2012T220[] V	22	±10%, ±20%	16	3.7	170	145	2.52	*2
CB C2012T470 U	47	±10%, ±20%	11	5.8	120	115	2.52	*2

#### **2016**(0806)type

	N		Self-resonant	DO D	Rated curren	t ※)[mA]		
Part number	Nominal inductance [ μ H]	Inductance tolerance	frequency [MHz] (min.)			Temperature rise current Idc2	Measuring frequency[MHz]	Note
CB 2016T1R0M V	1.0	±20%	100	0.09	600	720	7.96	*2
CB 2016T1R5M V	1.5	±20%	80	0.11	550	650	7.96	*2
CB 2016T2R2M V	2.2	±20%	70	0.13	510	600	7.96	*2
CB 2016T3R3M V	3.3	±20%	55	0.20	400	440	7.96	*2
CB 2016T4R7M V	4.7	±20%	45	0.25	340	410	7.96	*2
CB 2016T6R8M V	6.8	±20%	38	0.35	300	330	7.96	*2
CB 2016T100[] V	10	±10%, ±20%	32	0.50	250	270	2.52	*2
CB 2016T150[] V	15	±10%, ±20%	28	0.70	210	220	2.52	*2
CB 2016T220[] V	22	±10%, ±20%	16	1.0	165	190	2.52	*2
CB 2016T330□ V	33	±10%, ±20%	14	1.7	130	140	2.52	*2
CB 2016T470 V	47	±10%, ±20%	11	2.4	110	120	2.52	*2
CB 2016T680 V	68	±10%, ±20%	10	3.0	90	110	2.52	*2
CB 2016T101 ☐ V	100	±10%, ±20%	8	4.5	70	90	0.796	*2

	N		Self-resonant	DO D	Rated curren	t ※)[mA]		
Part number	Nominal inductance [ μ H]	Inductance tolerance	frequency [MHz] (min.)	DC Resistance [Ω](±30%)	Saturation current Idc1	Temperature rise current Idc2	Measuring frequency[MHz]	Note
CB C2016T1R0M V	1.0	±20%	100	0.10	1,100	885	7.96	*2
CB C2016T1R5M V	1.5	±20%	80	0.15	1,000	775	7.96	*2
CB C2016T2R2M V	2.2	±20%	70	0.20	750	625	7.96	*2
CB C2016T3R3M V	3.3	±20%	55	0.27	600	535	7.96	*2
CB C2016T4R7M V	4.7	±20%	45	0.37	550	460	7.96	*2
CB C2016T6R8M V	6.8	±20%	38	0.59	450	360	7.96	*2
CB C2016T100 U	10	±10%, ±20%	32	0.82	380	305	2.52	*2
CB C2016T150 U	15	±10%, ±20%	28	1.2	300	255	2.52	*2
CB C2016T220 U	22	±10%, ±20%	16	1.8	250	205	2.52	*2
CB C2016T330 U	33	±10%, ±20%	14	2.8	220	165	2.52	*2
CB C2016T470 U	47	±10%, ±20%	11	4.3	150	130	2.52	*2
CB C2016T680  V	68	±10%, ±20%	10	7.0	130	105	2.52	*2
CB C2016T101 V	100	±10%, ±20%	8	8.0	110	95	0.796	*2

<sup>• []</sup> Please specify the Inductance tolerance code (Kor M)

 $<sup>\</sup>frak{\%}$ ) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%.( at 20°C)

<sup>\*\*)</sup>The temperature rise current value (Idc2) is the DC current value having temperature increase by 20°C.( at 20°C)

\*\*)The rated current value is following either Idc1 or Idc2, which is the lower one.

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#### **2518(1007)** type

2010(1007) type	Nominal inductance		Self-resonant	DC Resistance	Rated curren	t ※)[mA]	Managina	
Part number	Nominal inductance [μH]	Inductance tolerance	frequency [MHz] (min.)	$[\Omega](\pm 30\%)$	Saturation current Idc1	Temperature rise current Idc2	Measuring frequency[MHz]	Note
CB 2518T1R0M V	1.0	±20%	100	0.06	1,200	1,250	7.96	*2
CB 2518T1R5M V	1.5	±20%	80	0.07	650	1,100	7.96	*2
CB 2518T2R2M V	2.2	±20%	68	0.09	510	1,000	7.96	*2
CB 2518T3R3M V	3.3	±20%	54	0.11	440	900	7.96	*2
CB 2518T4R7MRV	4.7	±20%	46	0.10	310	820	7.96	*2
CB 2518T4R7M V	4.7	±20%	46	0.13	340	820	7.96	*2
CB 2518T6R8M V	6.8	±20%	38	0.15	270	750	7.96	*2
CB 2518T100[] V	10	±10%, ±20%	30	0.25	250	600	2.52	*2
CB 2518T150[] V	15	±10%, ±20%	23	0.32	180	500	2.52	*2
CB 2518T220[] V	22	±10%, ±20%	19	0.50	165	390	2.52	*2
CB 2518T330□ V	33	±10%, ±20%	15	0.70	130	320	2.52	*2
CB 2518T470 V	47	±10%, ±20%	12	0.95	110	270	2.52	*2
CB 2518T680□ V	68	±10%, ±20%	9.5	1.5	70	210	2.52	*2
CB 2518T101 U	100	±10%, ±20%	9.0	2.1	60	190	0.796	*2
CB 2518T151 V	150	±10%, ±20%	7.0	3.2	55	140	0.796	*2
CB 2518T221□ V	220	±10%, ±20%	5.5	4.5	50	110	0.796	*2
CB 2518T331□ V	330	±10%, ±20%	4.5	7.0	40	90	0.796	*2
CB 2518T471 V	470	±10%, ±20%	3.5	10	35	70	0.796	*2
CB 2518T681 U	680	±10%, ±20%	3.0	17	30	50	0.796	*2
CB 2518T102[] V	1000	±10%, ±20%	2.4	24	25	45	0.252	*2

	Non-Soul Sodoubour		Self-resonant	DO De d'eterre	Rated curren	t ※)[mA]	Maranaian	
Part number	Nominal inductance [ μ H]	Inductance tolerance	frequency [MHz] (min.)			Temperature rise current Idc2	Measuring frequency[MHz]	Note
CB C2518T1R0M V	1.0	±20%	100	0.08	1,000	775	7.96	*2
CB C2518T1R5M V	1.5	±20%	80	0.11	950	730	7.96	*2
CB C2518T2R2M V	2.2	±20%	68	0.13	890	630	7.96	*2
CB C2518T3R3M V	3.3	±20%	54	0.16	730	560	7.96	*2
CB C2518T4R7M V	4.7	±20%	41	0.20	680	510	7.96	*2
CB C2518T6R8M V	6.8	±20%	38	0.30	550	420	7.96	*2
CB C2518T100[] V	10	±10%, ±20%	30	0.36	480	375	2.52	*2
CB C2518T150[] V	15	±10%, ±20%	23	0.65	350	285	2.52	*2
CB C2518T220[] V	22	±10%, ±20%	19	0.77	320	250	2.52	*2
CB C2518T330□ V	33	±10%, ±20%	15	1.5	270	185	2.52	*2
CB C2518T470  V	47	±10%, ±20%	12	1.9	240	165	2.52	*2
CB C2518T680 U	68	±10%, ±20%	9.5	2.8	200	140	2.52	*2
CB C2518T101 V	100	±10%, ±20%	9.0	3.7	160	125	0.796	*2
CB C2518T151 V	150	±10%, ±20%	7.0	6.1	140	95	0.796	*2
CB C2518T221 V	220	±10%, ±20%	5.5	8.4	115	80	0.796	*2
CB C2518T331 V	330	±10%, ±20%	4.5	12.3	100	65	0.796	*2
CB C2518T471 V	470	±10%, ±20%	3.5	22	80	50	0.796	*2
CB C2518T681 V	680	±10%, ±20%	3.0	28	65	45	0.796	*2

#### 3225 (1210) type

	Nicolard to decide a		Self-resonant	DO De cietamen	Rated curren	t ※)[mA]	Manager	
Part number	Nominal inductance [ μ H]	Inductance tolerance	frequency [MHz] (min.)	DC Resistance [Ω](±30%)	Saturation current Idc1	Temperature rise current Idc2	Measuring frequency[MHz]	Note
CB C3225T1R0MRV	1.0	±20%	250	0.055	2,000	1,100	0.1	*2
CB C3225T1R5MRV	1.5	±20%	220	0.060	2,000	1,000	0.1	*2
CB C3225T2R2MRV	2.2	±20%	190	0.080	2,000	930	0.1	*2
CB C3225T3R3MRV	3.3	±20%	160	0.095	2,000	850	0.1	*2
CB C3225T4R7MRV	4.7	±20%	70	0.100	1,250	830	0.1	*2
CB C3225T6R8MRV	6.8	±20%	50	0.120	950	760	0.1	*2
CB C3225T100∏RV	10	±10%, ±20%	23	0.133	900	720	0.1	*2
CB C3225T150□RV	15	±10%, ±20%	20	0.195	730	590	0.1	*2
CB C3225T220∏RV	22	±10%, ±20%	17	0.27	620	500	0.1	*2
CB C3225T330∏RV	33	±10%, ±20%	13	0.41	500	400	0.1	*2
CB C3225T470∏RV	47	±10%, ±20%	10	0.67	390	320	0.1	*2
CB C3225T680∏RV	68	±10%, ±20%	8.0	1.0	320	260	0.1	*2
CB C3225T101∏RV	100	±10%, ±20%	6.0	1.4	270	220	0.1	*2
CB C3225T221□RV	220	±10%, ±20%	3.0	2.5	190	170	0.1	*2
CB C3225T821∏RV	820	±10%, ±20%	1.8	12	110	80	0.1	*2
CB C3225T102∏RV	1000	±10%, ±20%	1.6	13	100	75	0.1	*2

<sup>· ☐</sup> Please specify the Inductance tolerance code(Kor M)

 $<sup>\</sup>mbox{\%}\mbox{)}$  The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%.( at 20°C)

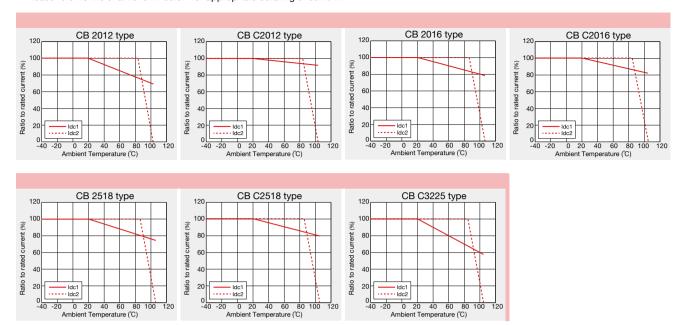
<sup>%</sup>) The temperature rise current value (Idc2) is the DC current value having temperature increase by 20°C.( at 20°C) %) The rated current value is following either Idc1 or Idc2, which is the lower one.

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#### ■ Derating of Rated Current

#### CB series

Derating of current is necessary for CB series depending on ambient temperature. Please refer to the chart shown below for appropriate derating of current.



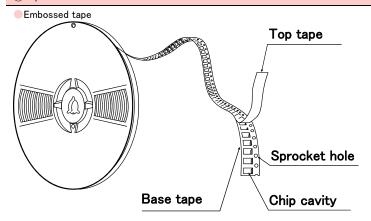
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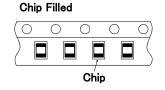
# WIRE-WOUND CHIP INDUCTORS (LB SERIES), WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES), WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

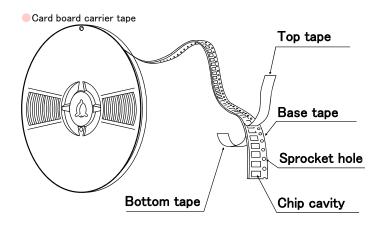
#### PACKAGING

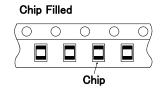
#### 1 Minimum Quantity Standard Quantity [pcs] Type Paper Tape Embossed Tape LB C3225 1000 CB C3225 LB 3218 2000 LB R2518 LB C2518 2000 LB 2518 CB 2518 CB C2518 LBM2016 LB C2016 LB 2016 2000 CB 2016 CB C2016 LB 2012 LB C2012 LB R2012 3000 CB 2012 CB C2012 CB L2012 4000 LB 1608 4000 LBMF1608 3000 CBMF1608

#### ②Tape material



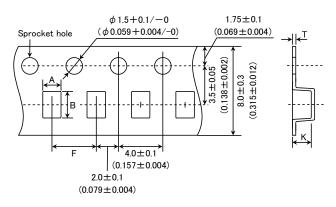






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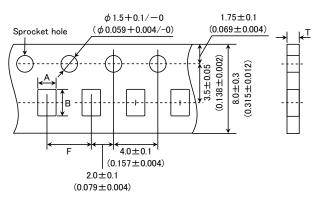
#### Embossed Tape (0.315 inches wide)



т.	Chip	cavity	Insertion pitch	Tape th	nickness
Type	Α	В	F	Т	K
LBM2016	1.75±0.1	2.1±0.1	4.0±0.1	0.3±0.05	1.9max.
	(0.069±0.004)	(0.083±0.004)	(0.157±0.004)	(0.012±0.002)	(0.075max.)
LB C3225	2.8±0.1	3.5±0.1	4.0±0.1	0.3±0.05	4.0max.
CB C3225	(0.110±0.004)	(0.138±0.004)	(0.157±0.004)	(0.012±0.002)	(0.157max.)
LB 3218	2.1±0.1	3.5±0.1	4.0±0.1	0.3±0.05	2.2max.
	(0.083±0.004)	(0.138±0.004)	(0.157±0.004)	(0.012±0.002)	(0.087max.)
LB 2518 CB 2518 LB C2518 CB C2518 LB R2518	2.15±0.1	2.7±0.1	4.0±0.1	0.3±0.05	2.2max.
	(0.085±0.004)	(0.106±0.004)	(0.157±0.004)	(0.012±0.002)	(0.087max.)
LB 2016 CB 2016 LB C2016 CB C2016	1.75±0.1 (0.069±0.004)	2.1±0.1 (0.083±0.004)	4.0±0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	1.9max. (0.075max.)
LB 2012 CB 2012 LB C2012 CB C2012 LB R2012	1.45±0.1 (0.057±0.004)	2.25±0.1 (0.089±0.004)	4.0±0.1 (0.157±0.004)	0.25±0.05 (0.010±0.002)	1.45max. (0.057max.)
LBMF1608	1.1±0.1	1.9±0.1	4.0±0.1	0.25±0.05	1.2max.
CBMF1608	(0.043±0.004)	(0.075±0.004)	(0.157±0.004)	(0.010±0.002)	(0.047max.)

Unit:mm(inch)

#### Card board carrier tape (0.315 inches wide)

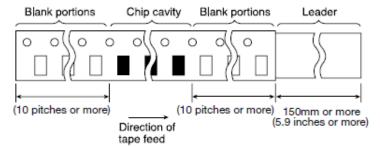


_	Chip	cavity	Insertion pitch	Tape thickness
Type A B		В	F	Т
OD 1 0010	1.55±0.1 2.3±0.1		4.0±0.1	1.1max.
CB L2012	$(0.061 \pm 0.004)$	$(0.091 \pm 0.004)$	$(0.157 \pm 0.004)$	(0.043max.)
LD 1000	1.0±0.1	1.8±0.1	4.0±0.1	1.1max.
LB 1608	$(0.039 \pm 0.004)$	$(0.071 \pm 0.004)$	$(0.157 \pm 0.004)$	(0.043max.)

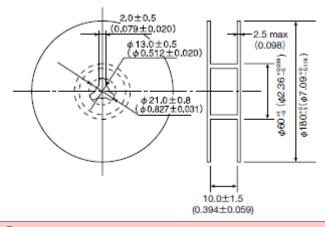
Unit:mm(inch)

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#### 4 Leader and Blank Portion



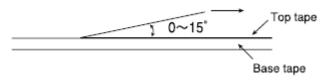
#### ⑤Reel Size



#### **©**Top Tape Strength

The top tape requires a peel-off force 0.2 to 0.7N in the direction of the arrow as illustrated below.

#### Pull direction



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# WIRE-WOUND CHIP INDUCTORS (LB SERIES), WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES), WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

#### ■RELIABILITY DATA

1.Operating tempera	ature Range			
1.Operating tempera	LB, LBC, LBR Series			
Specified Value	CB, CBC Series			
Specified Value	LBM Series	- 40 - 1 100 C (filefulling Self generated fleat)		
Test Methods and Remarks	Including self-generated heat	<u> </u>		
2. Storage Tempera	ture Range (after soldering)			
	LB, LBC, LBR Series			
Specified Value	CB, CBC Series	-40~+85°C		
	LBM Series	7		
Test Methods and	LB, CB Series:	1		
Remarks	Please refer the term of "7. storage conditions" in precautio	ns.		
3.Rated Current				
	LB, LBC, LBR Series			
Specified Value	CB, CBC Series	Within the specified tolerance		
	LBM Series			
4.Inductance				
	LB, LBC, LBR Series			
Specified Value	CB, CBC Series	Within the specified tolerance		
	LBM Series	<del>-</del>		
Test Methods and	LB·LBC·LBR·CB·CBC·LBM Series			
Remarks	Measuring equipment :LCR Mater(HP4285A or its	equivalent)		
5.Q				
	LB, LBC, LBR Series			
Specified Value	CB, CBC Series	7-		
	LBM Series	Within the specified tolerance		
Test Methods and	LBM Series			
Remarks	Measuring equipment : LCR Mater(HP4285A or its e	quivalent)		
6.DC Resistance				
	LB, LBC, LBR Series			
Specified Value	CB, CBC Series	Within the specified tolerance		
	LBM Series			
Test Methods and Remarks	Measuring equipment : DC Ohmmeter (HIOKI 3227 or its equ	uivalent)		
7.Self-Resonant Fre	equency			
	LB, LBC, LBR Series			
Specified Value	CB, CBC Series	Within the specified tolerance		
	LBM Series	1		
Test Methods and Remarks	Measuring equipment : Impedance analyzer (HP4291A or its	equivalent)		

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8.Temperature Char	racteristic					
	LBM2016	6				Inductance change : Within±10%
	LB2012	LBR2012	CB2012	LB2016		
	CB2016	LB2518	LBR2518	CB2518		Inductance change : Within±20%
Specified Value	LBC3225	GBC3225				
	LBC2016	GBC2016	LBC2518	CBC251	8	Mail: 1050/
	LB3218					Inductance change : Within±25%
	LBC2012	CBC2012				Inductance change : Within±35%
	Change of	of maximum inductan	ice deviation in	step 1-5		
	Step	Temp	erature(°C)			
	Step	LB,	CB Serie			
Test Methods and	1		20			
Remarks	2		-40			
	3	20(Reference temperature)		e)		
	4	+85(Maximum d	perating tempe	rature)		
	5		20	•		

9.Rasistance to Fle	xure of Substrate	
	LB, LBC, LBR Series	
Specified Value	CB, CBC Series	No damage.
	LBM Series	
Test Methods and Remarks	Warp : 2mm(LB·LBC·LBR·CB·CBC·LBM Series)  Test substrate : Board according to JIS C0051  Thickness : 1.0mm  Pressing jig  10 20	

10.Body Strength	10.Body Strength						
	LB, LBC, LBR Series						
Specified Value	CB, CBC Series	No damage.					
	LBM Series						
Test Methods and Remarks	LB·LBC·LBR·CB·CBC·LBM Applied force : 10N Duration : 10sec.						

11.Adhesion of term	ninal electrode			
Specified Value	LB, LBC, LBR Series			
	CB, CBC Series		No abnormality.	
	LBM Series			
Test Methods and Remarks	LB·LBC·LBR·CB Applied force Duration Test substrate	·CBC·CBL·LBM : 10N to X and Y directions 5 sec. : Printed board		

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12.Resistance to vib	oration				
	LB, LBC, LBR Series		Inductance change : Within±20%		
Specified Value	CB, CBC Series		No significant abnormality in appearance.		
	LBM Series		Inductance change : Within±20%  No significant abnormality in appearance.		
Test Methods and Remarks	Amplitude : 1.5mm  Mounting method : Soldering onto printed board				
13.Drop test					
Specified Value	LB, LBC, LBR Series CB, CBC Series LBM Series		_		
1					
14.Solderability					
	LB, LBC, LBR Series				
Specified Value	CB, CBC Series		At least 90% of surface of terminal electrode is covered by new		
		LBM Series			
Test Methods and Remarks	LB·LBC·LBR·CB·CB· Solder temperature Duration Flux	C+CBL+LBM: : 245±5°C : 5±0.5sec : Methanol solution with 25% of co	olophony		
	1				
15.Resistance to so	ldering				
	LB, LBC, LBR Series		1   1   1   1   1   1   1   1   1   1		
Specified Value	CB, CBC Series		Inductance change : Within±20%		
	LBM Series		Inductance change : Within±20%		
Test Methods and Remarks	LB·LBC·LBR·CB·CBC·CBL·LBM:  3 times of reflow oven at 230°C MIN for 40sec. with peak temperature at 260 °C for 5sec.				
1					
16.Resisitance to so					
	LB, LBC, LBR Series				
Specified Value	CB, CBC Series		_		
	LBM Series				
Test Methods and Remarks	Solvent temperature Type of solvent Cleaning conditions	: Room temperature : Isopropyl alcohol : 90s. Immersion and cleaning.			
17.Thermal shock					
17.THEITHAI SHOCK	LB, LBC, LBR Series				
Specified Value	CB, CBC Series		Inductance change : Within±20%  No significant abnormality in appearance.		
Specifica Value	LBM Series				
T . 11					
Test Methods and	LB·LBC·LBR·CB·CBC·CBL·LBM: $-40 \sim +85^{\circ}$ C, maintain times 30min. ,100 cycle  Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.				

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18.Damp heat life to	est				
Specified Value	LB, LBC, LBR Series		Inductance change : Within±20%  No significant abnormality in appearance.		
	CB, CBC Series				
	LBM Series				
	Temperature	: 60±2°C			
Test Methods and Remarks	Humidity	: 90~95%RH			
	Duration : 1000 hrs				
	Recovery	Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs			
19.Loading under da	ı				
	LB, LBC, LBR Series		Inductance change : Within±20%		
Specified Value	CB, CBC Series		No significant abnormality in appearance.		
	LBM Series		· ··		
	Temperature	: 60±2°C			
Test Methods and	Humidity	: 90~95%RH			
Remarks	Duration Applied current	: 1000 hrs : Rated current			
	Recovery		andard condition after the test, followed by the measurement within 48 hrs.		
	· · · · · · · · · · · · · · · · · · ·	·	•		
20.High temperature	e life test				
	LB, LBC, LBR Seri	ies	_		
Specified Value	CB. CBC Series		Industrian a share with the 2007		
opecined value	LBM Series		Inductance change : Within±20%  No significant abnormality in appearance.		
		. 05 ± 0°0	The significant above many in appearance.		
Test Methods and	Temperature : 85±2°C  Duration : 1000 hrs				
Remarks	Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.				
	<u> </u>				
21.Loading at high t	emperature life test				
	LD LDG LDD G L		Inductance change : Within±20%		
	LB, LBC, LBR Series		No significant abnormality in appearance.		
Specified Value	CB, CBC Series				
	LBM Series		<b></b>		
	Temperature	: 85±2°C			
Test Methods and	Duration				
Remarks	Applied current : Rated current				
	Recovery	: At least 2 hrs of recovery under the st	andard condition after the test, followed by the measurement within 48 hrs.		
22.Low temperature	I				
	LB, LBC, LBR Series		Inductance change : Within±20%		
Specified Value	CB, CBC Series		No significant abnormality in appearance.		
	LBM Series				
Test Methods and Remarks	Temperature	: -40±2°C			
	Duration : 1000 hrs  Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.				
	Recovery	: At least 2 rrs of recovery under the st	ariuaru coriuition after the test, followed by the measurement within 48 hrs.		
23.Standard conditi	I				
	LB, LBC, LBR Series		Standard test conditions  Unless specified, Ambient temperature is 20±15°C and the Relative		
	CB, CBC Series				
Specified Value	LBM Series		humidity is 65±20%. If there is any doubt about the test results, further measurement shall be had within the following limits:		
-			Ambient Temperature: 20±2°C		
			Relative humidity: 65±5%		
			Inductance value is based on our standard measurement systems.		

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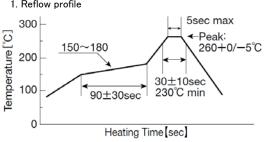
## WIRE-WOUND CHIP INDUCTORS (LB SERIES), WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES), WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

#### PRECAUTIONS

#### 1. Circuit Design 1. The products listed in this catalogue are intended for use in general electronic equipment (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment), general medical equipment, industrial equipment, and automotive Please be sure to contact TAIYO YUDEN for further information before using the products for any equipment which may directly cause Precautions loss of human life or bodily injury (e.g., specially controlled medical equipment, transportation equipment including, without limitation, automotive powertrain control system, train control system, and ship control system, traffic signal equipment). Please do not incorporate our products into any equipment requiring high levels of safety and/or reliability (e.g., aerospace equipment, aviation equipment, nuclear control equipment, undersea equipment, military equipment, etc.). 2. PCB Design ◆Land pattern design Precautions 1. Please contact any of our offices for a land pattern, and refer to a recommended land pattern of a right figure or specifications. [Recommended Land Patterns] Technical Surface Mounting considerations · Mounting and soldering conditions should be checked beforehand. · Applicable soldering process to those products is reflow soldering only. 3. Considerations for automatic placement ◆Adjustment of mounting machine Precautions 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards. 2. Mounting and soldering conditions should be checked beforehand. Technical 1. When installing products, care should be taken not to apply distortion stress as it may deform the products. considerations 4. Soldering ◆Reflow soldering( LB and CB Types) 1. For reflow soldering with either leaded or lead-free solder, the profile specified in "point for controlling" is recommended. Precautions ◆Recommended conditions for using a soldering iron 1. Put the soldering iron on the land-pattern. Soldering iron's temperature - Below 350°C Duration-3 seconds or less. The soldering iron

## ◆Reflow soldering( LB and CB Types) 1. Reflow profile

Technical considerations



should not come in contact with inductor directly.

- ◆Recommended conditions for using a soldering iron
- 1. Components can be damaged by excessive heat where soldering conditions exceed the specified range.

# Precautions Cleaning conditions Washing by supersonic waves shall be avoided. Technical considerations Technical tonsiderations Technical considerations Technical considerations Technical tonsiderations Technical tonsi

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6. Handling	
Precautions	<ul> <li>✦Handling</li> <li>1. Keep the inductors away from all magnets and magnetic objects.</li> <li>✦Breakaway PC boards(splitting along perforations)</li> <li>1. When splitting the PC board after mounting inductors, care should be taken not to give any stresses of deflection or twisting to the board.</li> <li>2. Board separation should not be done manually, but by using the appropriate devices.</li> <li>✦Mechanical considerations</li> <li>1. Please do not give the inductors any excessive mechanical shocks.</li> </ul>
Technical considerations	<ul> <li>✦ Handling</li> <li>1. There is a case that a characteristic varies with magnetic influence.</li> <li>✦ Breakaway PC boards( splitting along perforations)</li> <li>1. Planning pattern configurations and the position of products should be carefully performed to minimize stress.</li> <li>✦ Mechanical considerations</li> <li>1. There is a case to be damaged by a mechanical shock.</li> </ul>

7. Storage condi	tions
Precautions	<ul> <li>♦ Storage</li> <li>1. To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled.</li> <li>• Recommended conditions         Ambient temperature:0~40°C / Humidity:Below 70% RH         The ambient temperature must be kept below 30°C even under ideal storage conditions, solderability of products electrodes may decrease as time passes. For this reason, These series should be used within 6 months from the time of delivery.     </li> </ul>
Technical considerations	◆Storage 1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place.